

## **Excellent Integrated System Limited**

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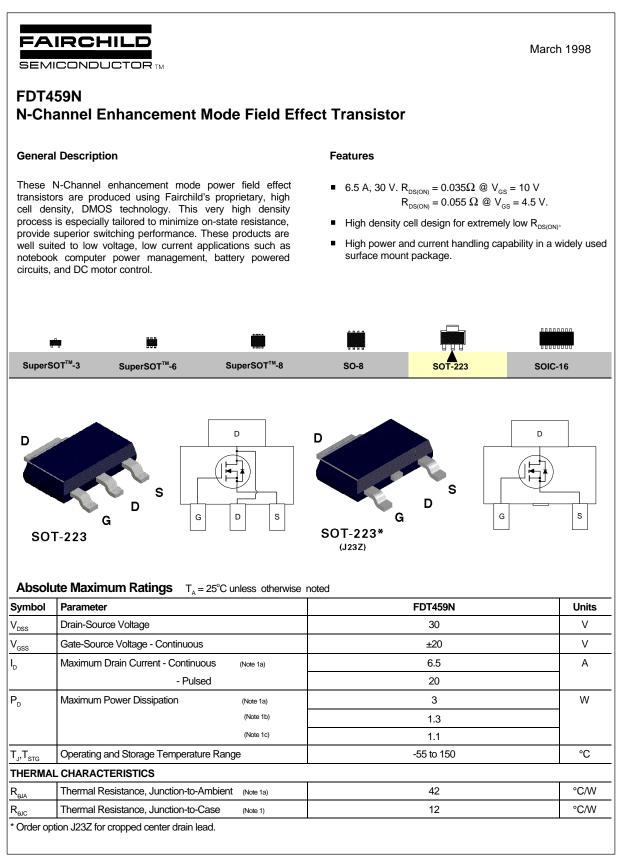
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Fairchild Semiconductor FDT459N

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**Distributor of Fairchild Semiconductor: Excellent Integrated System Limited** Datasheet of FDT459N - MOSFET N-CH 30V 6.5A SOT-223 Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



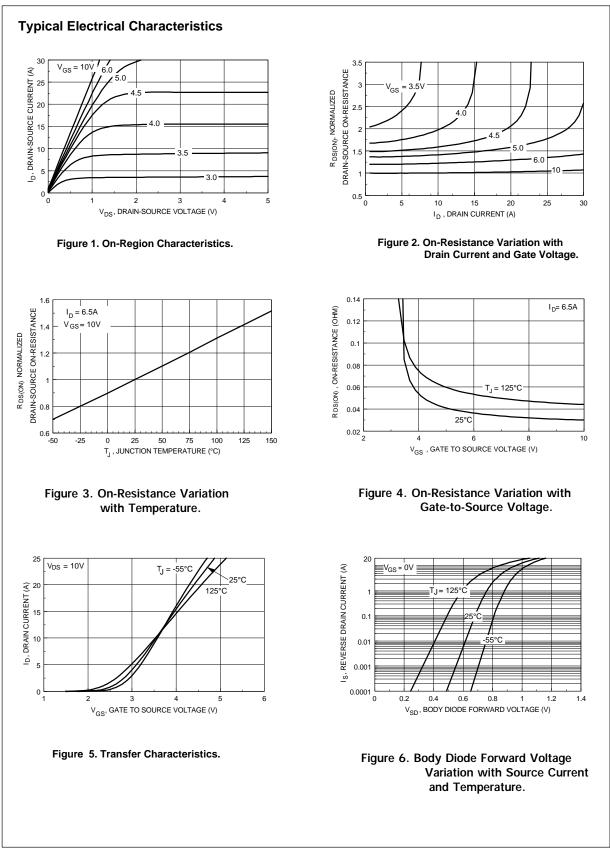
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Symbol	Parameter	Conditions		Min	Тур	Max	Units
FF CHAR	ACTERISTICS				1		
V <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$		30			V
BV <sub>DSS</sub> /ΔT <sub>J</sub>	Breakdown Voltage Temp. Coefficient	$I_{\rm p}$ = 250 µA, Referenced to 25 °C			33		mV/°C
ss	Zero Gate Voltage Drain Current	$V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}$				1	μA
			T_=55°C			10	μA
iSSF	Gate - Body Leakage, Forward	V <sub>GS</sub> = 20 V, V <sub>DS</sub> = 0 V				100	nA
SSR	Gate - Body Leakage, Reverse	$V_{gs} = -20 \text{ V}, \text{ V}_{ps} = 0 \text{ V}$				-100	nA
N CHARA	CTERISTICS (Note 2)						
GS(th)	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$		1	1.6	2	V
$V_{GS(th)}/\Delta T_{J}$	Gate Threshold Voltage Temp.Coefficient	$I_{D} = 250 \ \mu A$ , Referenced	to 25 °C		-4.2		mV/°C
DS(ON)	Static Drain-Source On-Resistance	$V_{GS} = 10 \text{ V}, I_{D} = 6.5 \text{ A}$			0.031	0.035	Ω
00(014)		00 0	T <sub>J</sub> =125℃		0.044	0.06	-
		$V_{GS} = 4.5 \text{ V}, \ \text{I}_{D} = 5.5 \text{ A}$	5		0.046	0.055	-
(ON)	On-State Drain Current	$V_{GS} = 10 \text{ V}, \text{ V}_{DS} = 5 \text{ V}$		20			A
=s	Forward Transconductance	$V_{\rm DS} = 10 \text{ V}, \ \text{I}_{\rm D} = 6.5 \text{ A}$			16		S
-	HARACTERISTICS						
iss	Input Capacitance	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V},$			365		pF
oss	Output Capacitance	f = 1.0 MHz			210		pF
rss	Reverse Transfer Capacitance				70		pF
WITCHING	G CHARACTERISTICS (Note 2)						
(on)	Turn - On Delay Time	$V_{DD} = 15 \text{ V}, \ \text{I}_{D} = 1 \text{ A},$			5.2	11	ns
	Turn - On Rise Time	$V_{gs} = 10 \text{ V}, \text{ R}_{gen} = 6 \Omega$			8.2	16	ns
D(off)	Turn - Off Delay Time		-		6	12	ns
	Turn - Off Fall Time				16	26	ns
<b>)</b> g	Total Gate Charge	$V_{\rm DS} = 10 \ V, \ I_{\rm D} = 6.5 \ A,$			12	17	nC
) <sub>gs</sub>	Gate-Source Charge	V <sub>GS</sub> = 10 V			2.2		nC
) <sub>gd</sub>	Gate-Drain Charge				3		nC
RAIN-SOL	IRCE DIODE CHARACTERISTICS AND MAX	IMUM RATINGS				-	
6	Maximum Continuous Drain-Source Diode Fo	rward Current				2.5	Α
SD	Drain-Source Diode Forward Voltage	$V_{\rm GS} = 0 \ V, \ I_{\rm S} = 2.5 \ A$ (Not	e 2)		0.8	1.2	V
I <sub>S</sub> V <sub>SD</sub> Notes: 1. R <sub>ain</sub> is the sur design while F	Maximum Continuous Drain-Source Diode Fo	$V_{GS} = 0 \text{ V}, \text{ I}_{S} = 2.5 \text{ A} \text{ (Not}$ where the case thermal reference is define		ting surface		1.2	uarant
	a. 42°C/W when mounted on a 1 in <sup>2</sup> pad c 2oz Cu.	b. 95°C/W when m pad of 2oz Cu.	nounted on a 0.066	in² ↓	in² pad o	C/W when mo	ounted on

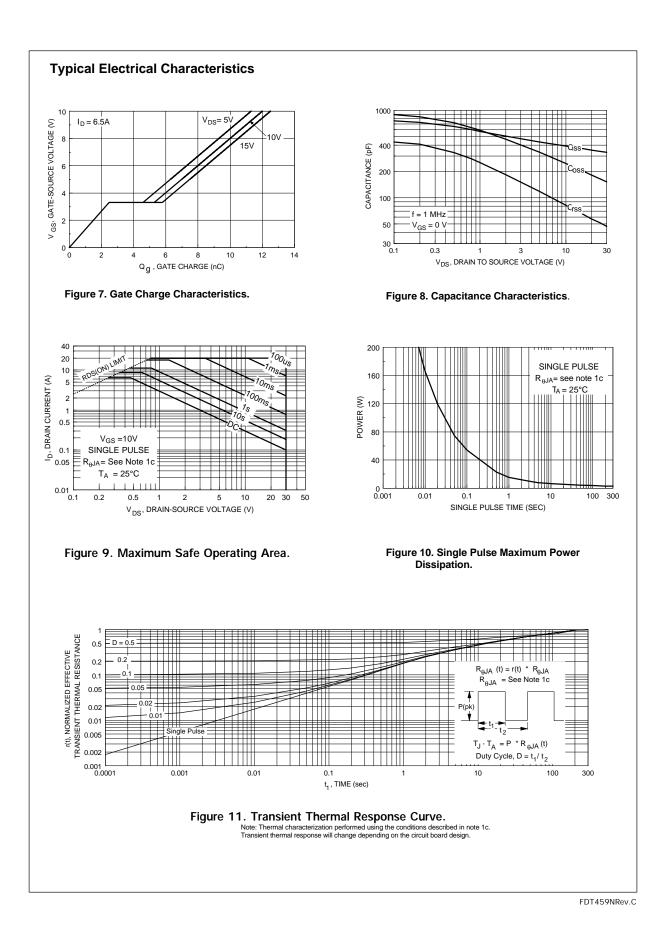
FDT459NRev.C





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Rev. H4